

### 2.0x1.25mm SMD CHIP LED LAMP

Part Number: KPHCM-2012CGCK Green

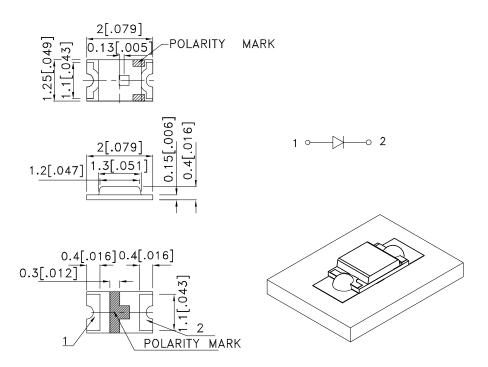
#### **Features**

- 2.0X1.25mm SMT LED,0.5mm max. thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

## Description

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

# **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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# **Selection Guide**

Part No.	Part No. Dice Lens Type		lv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
KPHCM-2012CGCK	Green (AlGaInP)	Water Clear	20	50	110°

### Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

# Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	570		nm	I==20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	IF=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.1	2.5	V	I==20mA
lr	Reverse Current	Green		10	uA	V <sub>R</sub> =5V

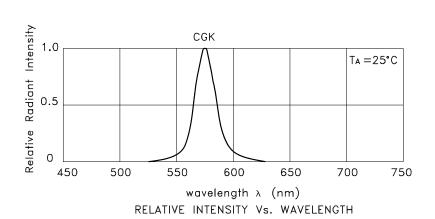
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

# Absolute Maximum Ratings at TA=25°C

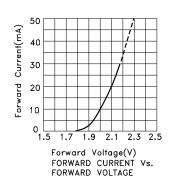
Green	Units					
75	mW					
30	mA					
150	mA					
5	V					
-40°C To +85°C	-40°C To +85°C					
-40°C To +85°C	-40°C To +85°C					
	Green  75  30  150  5  -40°C To +85°C					

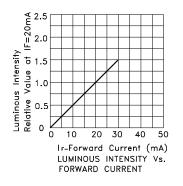
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

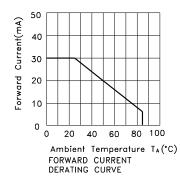
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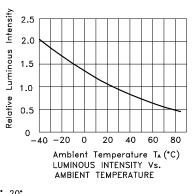


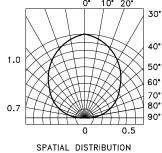
## Green KPHCM-2012CGCK











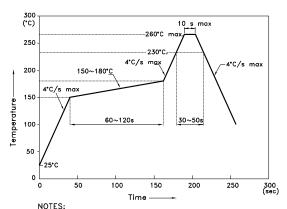
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### KPHCM-2012CGCK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



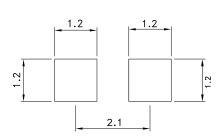
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

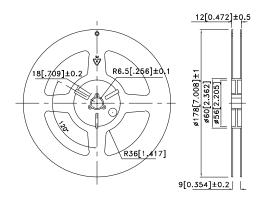
  3.Number of reflow process shall be 2 times or less.

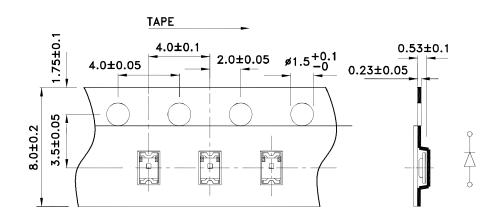
# Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



# Tape Dimensions (Units: mm)

## **Reel Dimension**



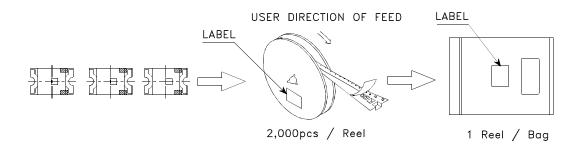


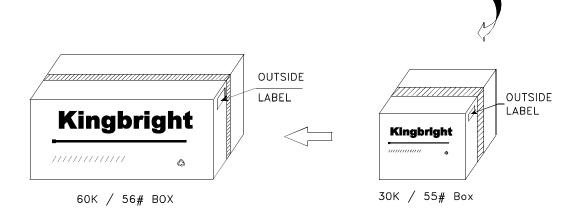
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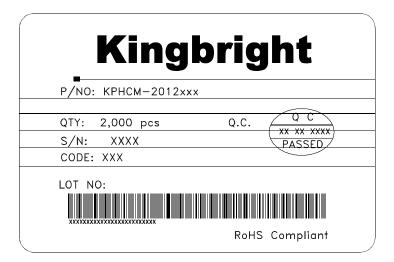
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# PACKING & LABEL SPECIFICATIONS

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